



PRODUCT DATASHEET



- PLCC2 SMD
- 3528 1.9t Series
- Yellow (590nm)





N0Y45S02

APPLICATIONS:

- Decorative Lighting
- Backlighting
- Indicator
- Dashboard
- Display

3528 1.9t Series



FEATURES:

- Package: PLCC2 Top View White SMT Package
- Forward Current: 20mA
- Forward Voltage (typ.): 2.0V
- Luminous Intensity (typ.): 600mcd@20mA
- Colour: Yellow
- Wavelength: 590nm
- Viewing angle: 120°
- Materials:
 - Die: AlGaInP
 - Resin: Silicon (Water Clear)
 - L/T Finish: Ag plated
- Operating Temperature: -40~+85°C
- Storage Temperature: -40~+100°C
- ESD (HBM): 2kV

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- Grouping parameters:
 - Forward voltage
 - Luminous intensity
 - Dominant Wavelength
- Soldering methods: IR Reflow
 - MSL: acc. to JEDEC Level 2a (J-STD20D)
 - Packing: 8mm tape with Max.2000/reel, ø180mm (7")





CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
Forward Current	lF	30	mA
Pulse Forward Current Duty 1/10, width 0.1ms	IPF	100	Ma
Reverse Voltage	V _R	10	V
Reverse Current @10V	IR	10	μΑ
Junction Temperature	Tj	110	°C
Electrostatics Discharge (HBM)	ESD	2000	V
Operating Temperature	T _{OPR}	-40~+85	°C
Storage Temperature	Тѕтб	-40~+100	°C
Soldering Temperature	T _{sD}	260	°C

Electrical & Optical Characteristics (Ta=25°C)

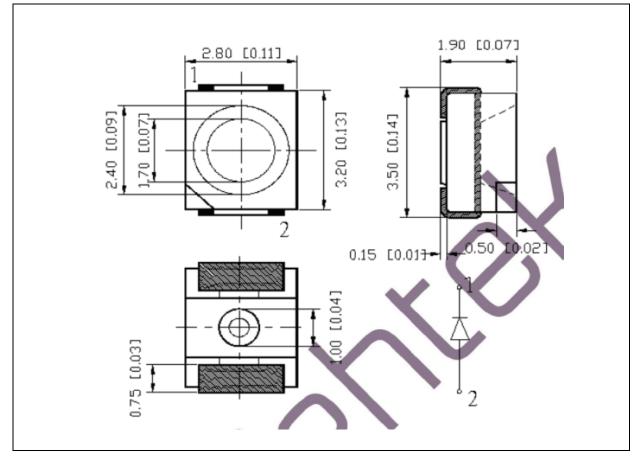
Parameter	Symbol	Values			Unit	Test
Parameter Symbo	Symbol	Min.	Тур.	Max.	Unit	Condition
Forward Voltage	VF	1.7	2.0	2.5	V	I⊧=20mA
Luminous Intensity	Iv	460	600	1000	mcd	I⊧=20mA
Dominant Wavelength	λ_{D}	585		597	nm	I⊧=20mA
Viewing Angle	2 θ 1/2		120		deg	I⊧=20mA

 $1. \qquad \text{Luminous intensity} \ (I_{v}) \pm 10\%, \ \text{Forward Voltage} \ (V_{F}) \pm 0.1V, \ \text{Viewing angle} (2\theta_{1/2}) \pm 5\%, \ \text{Wavelength} \pm 1nm$



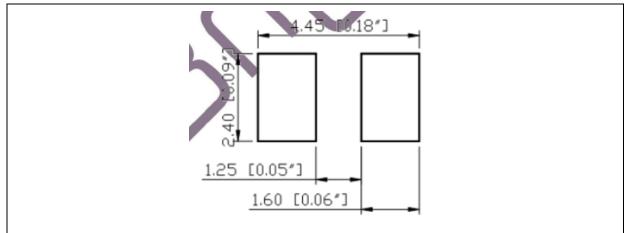
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ± 0.1 mm with angle tolerance $\pm 0.5^{\circ}$.



BINNING GROUPS:

Code	Min.	Max.	Unit
А	1.7	1.8	
В	1.8	1.9	
С	1.9	2.0	
D	2.0	2.1	V
E	2.1	2.2	v
F	2.2	2.3	
G	2.3	2.4	
Н	2.4	2.5	

Forward Voltage Classifications (I_F = 20mA):

Luminous Intensity Classifications (I_F = 20mA):

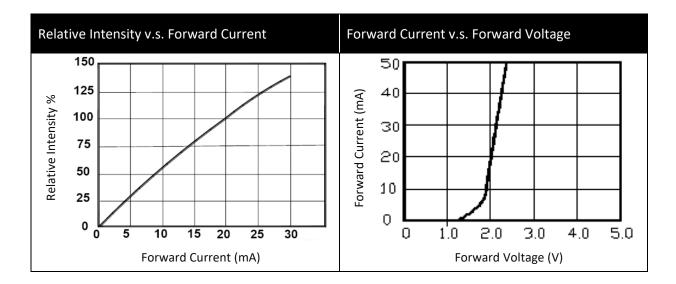
Code	Min.	Max.	Unit
12	460	600	
13	600	780	mcd
14	780	1000	

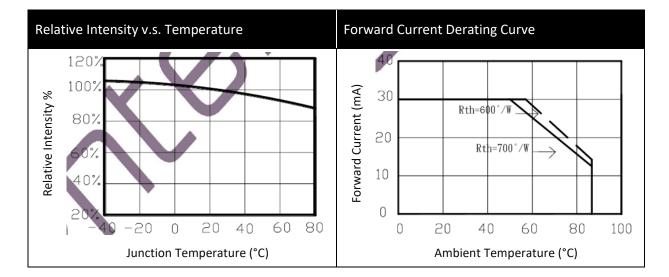
Dominant Wavelength Classifications (I_F = 20mA):

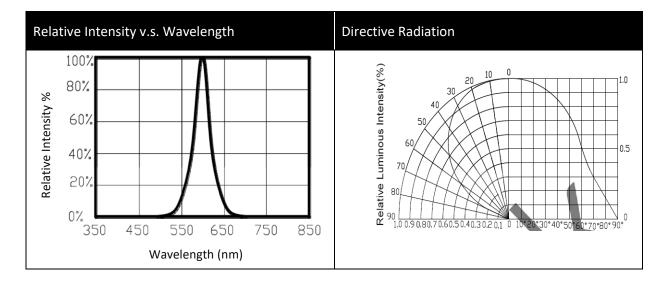
Code	Min.	Max.	Unit
С	585	588	
D	588	591	
E	591	594	nm
F	594	597	



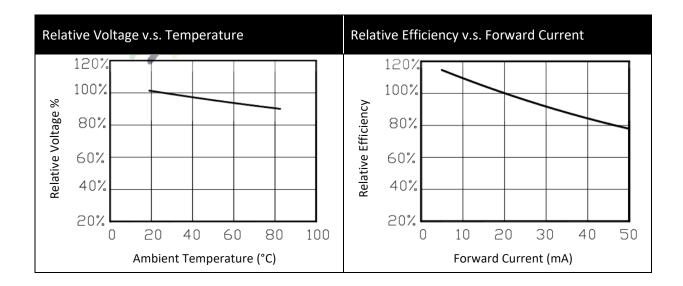
ELECTRO-OPTICAL CHARACTERISTICS:







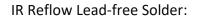


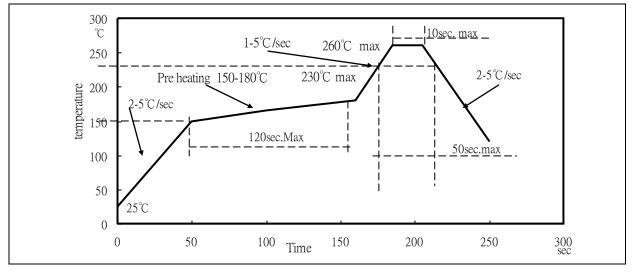


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RECOMMENDED SOLDERING PROFILE:





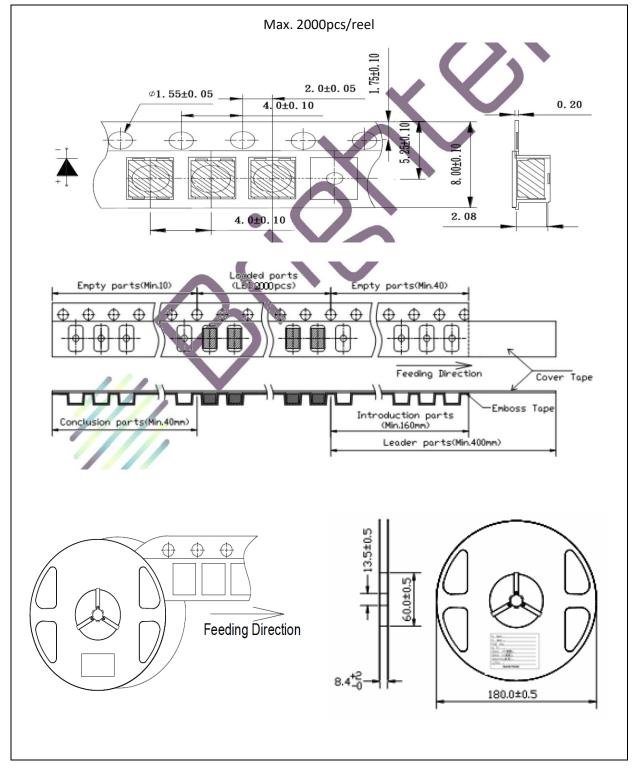
Note:

- 1. Maximum reflow soldering: 3 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended reflow temperature 240°C. The maximum soldering temperature should be limited to 260°C.



PACKING SPECIFICATION:

Reel Dimension:



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PRECAUTIONS OF USE:



Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent and apply baking at 60°C±5°C for 15hrs before use.

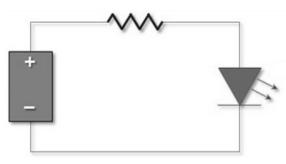
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, for reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	28/11/2016	Datasheet set-up.
A1.3	23/02/2018	New datasheet format.